

# TUSB320LI、TUSB320HI USB Type-C 配置通道逻辑和端口控制

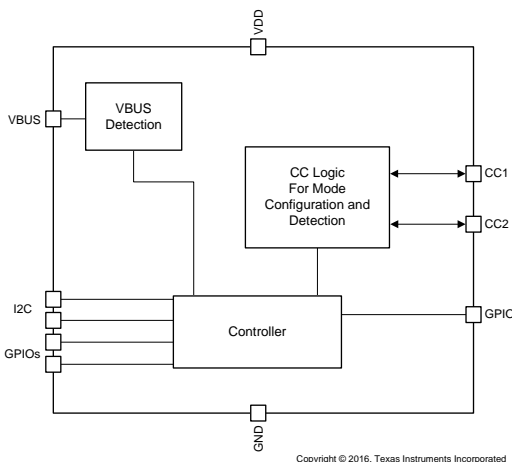
## 1 特性

- USB Type-C™ 规范 1.1
- 向后兼容 USB Type-C 规范 1.0
- 支持高达 3A 的电流通告和检测
- 模式配置
  - 仅主机 - 下行端口 (DFP) (供电设备)
  - 仅设备 - 上行端口 (UFP) (受电设备)
  - 双角色端口 - DRP
  - 支持 Try.SRC 和 Try.SNK
- 通道配置 (CC)
  - USB 端口连接检测
  - 电缆方向检测
  - 角色检测
  - Type-C 电流模式 (默认、中等和高)
- $V_{BUS}$  检测
- I<sup>2</sup>C 或 GPIO 控制
- 通过 I<sup>2</sup>C 实现角色配置控制
- 电源电压: 2.7V 至 5V
- 低电流消耗
- 工业温度范围: -40°C 至 85°C

## 2 应用

- 主机、设备、双角色端口 应用
- 移动电话
- 平板电脑和笔记本电脑
- USB 外设

简化电路原理图



## 3 说明

TUSB320LI 和 TUSB320HI 器件 (除非另外注明, 否则本文档后续部分将统称为 TUSB320) 可在 USB Type-C 端口上实现 Type-C 生态系统所需的配置通道 (CC) 逻辑。TUSB320 器件使用 CC 引脚来确定端口的连接状态和电缆方向, 以及进行角色检测和 Type-C 电流模式控制。TUSB320 器件可配置为下行端口 (DFP)、上行端口 (UFP) 或双角色端口 (DRP), 因此成为任何应用的理想选择。

根据 Type-C 规范, TUSB320 会交替配置为 DFP 或 UFP。CC 逻辑块通过监视 CC1 和 CC2 引脚上的上拉或下拉电阻, 以确定何时连接了 USB 端口、电缆的方向以及检测到的角色。CC 逻辑根据检测到的角色来确定 Type-C 电流模式为默认、中等还是高。该逻辑通过实施  $V_{BUS}$  检测来确定端口在 UFP 和 DRP 模式下是否连接成功。

该系列器件能够在宽电源范围内工作, 并且具有较低功耗。TUSB320 提供两种使能版本: 低电平有效使能, 称为 TUSB320LI; 高电平有效使能, 称为 TUSB320HI。TUSB320 系列器件适用于工业级温度范围。

器件信息(1)

器件型号	封装	封装尺寸 (标称值)
TUSB320HI	X2QFN (12)	1.60mm x 1.60mm
TUSB320LI	X2QFN (12)	1.60mm x 1.60mm

(1) 要了解所有可用封装, 请参见数据表末尾的可订购产品附录。

示例应用



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## 4 修订历史记录

### Changes from Revision C (October 2016) to Revision D Page

- Changed R<sub>VBUS</sub> values From: MIN = 891, TYP = 900, MAX = 909 KΩ To: MIN = 855, TYP = 887, MAX = 920 KΩ ..... 6

### Changes from Revision B (September 2016) to Revision C Page

- Changed text for Pin 7 in the *Pin Functions* table From: "default current mode detected (H); medium or high current mode detected (L)." To: "Refer to [Table 3](#) for more details." ..... 3
- Changed text for Pin 8 in the *Pin Functions* table From: "default or medium current mode detected (H); high current mode detected (L)." To: "Refer to [Table 3](#) for more details." ..... 3

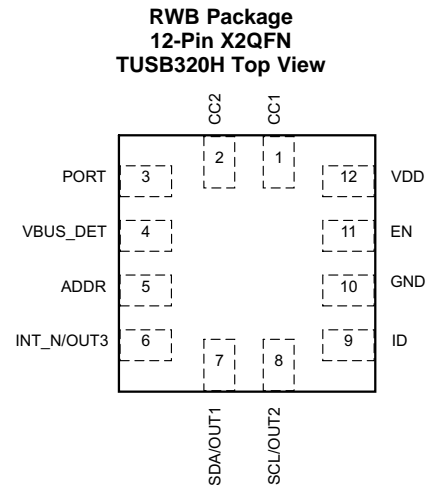
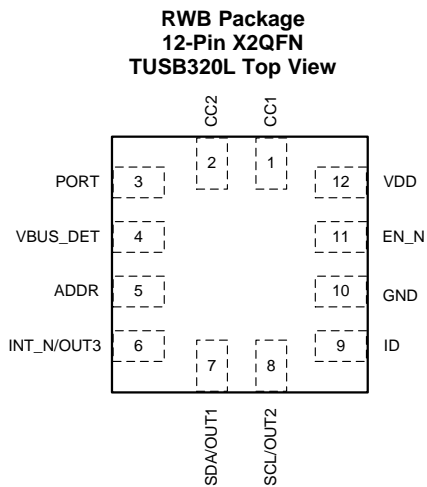
### Changes from Revision A (February 2016) to Revision B Page

- Changed pins CC1 and CC2 values From: MIN = -0.3 MAX = V<sub>DD</sub> + 0.3 To: MIN -0.3 MAX = 6 in the [Absolute Maximum Ratings](#) ..... 4

### Changes from Original (August 2015) to Revision A Page

- Added Note 1 and 2 to the *Pin Functions* table ..... 3
- Changed the DESCRIPTION of pin EN\_N pin in the *Pin Functions* table ..... 4
- Changed the DESCRIPTION of pin EN pin in the *Pin Functions* table ..... 4
- Changed the DESCRIPTION of pin V<sub>DD</sub> in the *Pin Functions* table ..... 4
- Added Note 2 to the [Electrical Characteristics](#) table ..... 5
- Added Test Condition "See [Figure 1](#)" to VBUS\_THR in the [Electrical Characteristics](#) ..... 6
- Replaced the [Timing Requirements](#) table ..... 6
- Added Note: "SW must make sure..." to the Description of INTERRUPT\_STATUS in [Table 9](#) ..... 18
- Added text to list item 2 in the [TUSB320L Initialization Procedure](#) section ..... 28
- Added text to list item 2 in the [TUSB320H Initialization Procedure](#) section ..... 28

## 5 Pin Configuration and Functions



### Pin Functions

NAME	PIN NO.		TYPE	DESCRIPTION
	TUSB320L	TUSB320H		
CC1	1	1	I/O	Type-C configuration channel signal 1
CC2	2	2	I/O	Type-C configuration channel signal 2
PORT <sup>(1)</sup>	3	3	I	Tri-level input pin to indicate port mode. The state of this pin is sampled when TUSB320L's EN_N is asserted low, TUSB320H's EN is asserted high, and VDD is active. This pin is also sampled following a I2C_SOFT_RESET. H - DFP (Pull-up to VDD if DFP mode is desired) NC - DRP (Leave unconnected if DRP mode is desired) L - UFP (Pull-down or tie to GND if UFP mode is desired)
VBUS_DET <sup>(1)</sup>	4	4	I	5- to 28-V VBUS input voltage. VBUS detection determines UFP attachment. One 900-kΩ external resistor required between system VBUS and VBUS_DET pin.
ADDR <sup>(1)</sup>	5	5	I	Tri-level input pin to indicate I2C address or GPIO mode: H - I2C is enabled and I2C 7-bit address is 0x67. NC - GPIO mode (I2C is disabled) L - I2C is enabled and I2C 7-bit address is 0x47. ADDR pin should be pulled up to VDD if high configuration is desired
INT_N/OUT3 <sup>(1)</sup>	6	6	O	The INT_N/OUT3 is a dual-function pin. When used as the INT_N, the pin is an open drain output in I2C control mode and is an active low interrupt signal for indicating changes in I2C registers. When used as OUT3, the pin is in audio accessory detect in GPIO mode: no detection (H), audio accessory connection detected (L).
SDA/OUT1 <sup>(1)(2)</sup>	7	7	I/O	The SDA/OUT1 is a dual-function pin. When I2C is enabled (ADDR pin is high or low), this pin is the I2C communication data signal. When in GPIO mode (ADDR pin is NC), this pin is an open drain output for communicating Type-C current mode detect when the device is in UFP mode: Refer to Table 3 for more details.
SCL/OUT2 <sup>(1)(2)</sup>	8	8	I/O	The SCL/OUT2 is a dual function pin. When I2C is enabled (ADDR pin is high or low), this pin is the I2C communication clock signal. When in GPIO mode (ADDR pin is NC), this pin is an open drain output for communicating Type-C current mode detect when the device is in UFP mode: Refer to Table 3 for more details.
ID <sup>(1)</sup>	9	9	O	Open drain output; asserted low when the CC pins detect device attachment when port is a source (DFP), or dual-role (DRP) acting as source (DFP).
GND	10	10	G	Ground

(1) When VDD is off, the TUSB320 non-failsafe pins (VBUS\_DET, ADDR, PORT, ID, OUT[3:1] pins) could back-drive the TUSB320 device if not handled properly. When necessary to pull these pins up, it is recommended to pullup PORT, ADDR, INT\_N/OUT3, and ID to the device VDD supply. The VBUS\_DET must be pulled up to VBUS through a 900-kΩ resistor.

(2) When using the 3.3 V supply for I2C, the end user must ensure that the VDD is 3 V and above. Otherwise the I2C may back power the device.

**Pin Functions (continued)**

NAME	PIN		TYPE	DESCRIPTION
	NO.			
	TUSB320L	TUSB320H		
EN_N	11	—	I	Enable signal; active low. Pulled up to $V_{DD}$ internally to disable the TUSB320L device. If controlled externally, must be held low at least for 50 ms after VDD has reached its valid voltage level.
EN	—	11	I	Enable signal; active high. Pulled down to GND internally to disable the TUSB320H device. If controlled externally, must be held low at least for 50 ms after VDD has reached its valid voltage level.
$V_{DD}$	12	12	P	Positive supply voltage. $V_{DD}$ must ramp within 25 ms or less

## 6 Specifications

### 6.1 Absolute Maximum Ratings

 over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
Supply voltage	$V_{DD}$	-0.3	6.0	V
Control pins	CC1, CC2, PORT, ADDR, ID, EN_N, INT_N/OUT3	-0.3	$V_{DD} + 0.3$	V
	CC1, CC2	-0.3	6	
	SDA/OUT1, SCL/OUT2	-0.3	$V_{DD} + 0.3$	
	VBUS_DET, EN	-0.3	4	
Storage temperature, $T_{stg}$		-65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±5000	V
	Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup>	±1500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
$V_{DD}$	Supply voltage range	2.7		5	V
$V_{BUS}$	System $V_{BUS}$ voltage	4	5	28	V
$T_A$	TUSB320HI and TUSB320LI Operating free air temperature range	-40	25	85	°C

### 6.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>		TUSB320	UNIT
		RWB (X2QFN)	
		12 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	169.3	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	68.1	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	83.4	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	2.2	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	83.4	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	N/A	

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and C Package Thermal Metrics* application report, [SPRA953](http://SPRA953).

## 6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>Power Consumption</b>						
$I_{UNATTACHED\_UFP}$	Current consumption in unattached mode when port is unconnected and waiting for connection. ( $V_{DD} = 4.5\text{ V}$ , $EN\_N$ (TUSB320L) = L, $EN$ (TUSB320H) = H, $ADDR = NC$ , $PORT = L$ )			100		$\mu\text{A}$
$I_{ACTIVE\_UFP}$	Current consumption in active mode. ( $V_{DD} = 4.5\text{ V}$ , $EN\_N$ (TUSB320L) = L, $EN$ (TUSB320H) = H, $ADDR = NC$ , $PORT = L$ )			100		$\mu\text{A}$
$I_{SHUTDOWN}$	Leakage current when $V_{DD}$ is supplied, but the TUSB320 device is not enabled. ( $V_{DD} = 4.5\text{ V}$ , $EN\_N$ (TUSB320L) = H, $EN$ (TUSB320H) = L)			0.040		$\mu\text{A}$
<b>CC1 and CC2 Pins</b>						
$R_{CC\_DB}$	Pulldown resistor when in dead-battery mode.		4.1	5.1	6.1	$\text{k}\Omega$
$R_{CC\_D}$	Pulldown resistor when in UFP or DRP mode.		4.6	5.1	5.6	$\text{k}\Omega$
$V_{TH\_UFP\_CC\_USB}$	Voltage threshold for detecting a DFP attach when configured as a UFP and DFP is advertising default current source capability.		0.15	0.2	0.25	V
$V_{TH\_UFP\_CC\_MED}$	Voltage threshold for detecting a DFP attach when configured as a UFP and DFP is advertising medium (1.5 A) current source capability.		0.61	0.66	0.7	V
$V_{TH\_UFP\_CC\_HIGH}$	Voltage threshold for detecting a DFP attach when configured as a UFP and DFP is advertising high (3 A) current source capability.		1.169	1.23	1.29	V
$V_{TH\_DFP\_CC\_USB}$	Voltage threshold for detecting a UFP attach when configured as a DFP and advertising default current source capability.		1.51	1.6	1.64	V
$V_{TH\_DFP\_CC\_MED}$	Voltage threshold for detecting a UFP attach when configured as a DFP and advertising medium current (1.5 A) source capability.		1.51	1.6	1.64	V
$V_{TH\_DFP\_CC\_HIGH}$	Voltage threshold for detecting a UFP attach when configured as a DFP and advertising high current (3.0 A) source capability.		2.46	2.6	2.74	V
$I_{CC\_DEFAULT\_P}$	Default mode pullup current source when operating in DFP or DRP mode.		64	80	96	$\mu\text{A}$
$I_{CC\_MED\_P}$	Medium (1.5 A) mode pullup current source when operating in DFP or DRP mode.		166	180	194	$\mu\text{A}$
$I_{CC\_HIGH\_P}$	High (3 A) mode pullup current source when operating in DFP or DRP mode. <sup>(1)</sup>		304	330	356	$\mu\text{A}$
<b>Control Pins: PORT, ADDR, INT/OUT3, EN_N, EN, ID</b>						
$V_{IL}$	Low-level control signal input voltage (PORT, ADDR, EN_N, EN)				0.4	V
$V_{IM}$	Mid-level control signal input voltage (PORT, ADDR)		$0.28 \times V_{DD}$		$0.56 \times V_{DD}$	V
$V_{IH}$	High-level control signal input voltage (PORT, ADDR, EN_N)		$V_{DD} - 0.3$		$V_{DD}$	V
$V_{IH\_EN}$	High-Level control signal input voltage for EN for TUSB320H		1.05		3.65	V
$I_{IH}$	High-level input current		-20		20	$\mu\text{A}$
$I_{IL}$	Low-level input current		-10		10	$\mu\text{A}$
$R_{EN\_N}$	Internal pullup resistance for EN_N for TUSB320L			1.1		$\text{M}\Omega$
$R_{EN}$	Internal pulldown resistance for EN for TUSB320H			500		$\text{k}\Omega$
$R_{pu}^{(2)}$	Internal pullup resistance (PORT, ADDR)			588		$\text{k}\Omega$
$R_{pd}^{(2)}$	Internal pulldown resistance (PORT, ADDR)			1.1		$\text{M}\Omega$
$V_{OL}$	Low-level signal output voltage (open-drain) (INT_N/OUT3, ID)	$I_{OL} = -1.6\text{ mA}$			0.4	V
$R_{p\_ODext}$	External pullup resistor on open drain IOs (INT_N/OUT3, ID)			200		$\text{k}\Omega$
$R_{p\_TLezt}$	Tri-level input external pullup resistor (PORT, ADDR)			4.7		$\text{k}\Omega$

(1)  $V_{DD}$  must be 3.5 V or greater to advertise 3 A current.

(2) Internal pullup and pulldown for PORT and ADDR are removed after the device has sampled EN = high or EN\_N = low.

## Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>I<sup>2</sup>C - SDA/OUT1, SCL/OUT2 can operate from 1.8 or 3.3 V (±10%)<sup>(3)</sup></b>						
V <sub>DD,I2C</sub>	Supply range for I <sup>2</sup> C (SDA/OUT1, SCL/OUT2)		1.65	1.8	3.6	V
V <sub>IH</sub>	High-level signal voltage		1.05		3.6	V
V <sub>IL</sub>	Low-level signal voltage				0.4	V
V <sub>OL</sub>	Low-level signal output voltage (open drain)	I <sub>OL</sub> = -1.6 mA			0.4	V
<b>VBUS_DET IO Pins (Connected to System V<sub>BUS</sub> signal)</b>						
V <sub>BUS,THR</sub>	V <sub>BUS</sub> threshold range	See Figure 1	2.95	3.30	3.80	V
R <sub>VBUS</sub>	External resistor between V <sub>BUS</sub> and VBUS_DET pin		855	887	920	KΩ
R <sub>VBUS,PD</sub>	Internal pulldown resistance for VBUS_DET			95		KΩ

 (3) When using 3.3 V for I<sup>2</sup>C, customer must ensure V<sub>DD</sub> is above 3 V at all times.

## 6.6 Timing Requirements

		MIN	NOM	MAX	UNIT
<b>I<sup>2</sup>C (SDA, SCL)</b>					
t <sub>SU,DAT</sub>	Data setup time	100			ns
t <sub>HD,DAT</sub>	Data hold time	10			ns
t <sub>SU,STA</sub>	Set-up time, SCL to start condition	0.6			μs
t <sub>HD,STA</sub>	Hold time (repeated), start condition to SCL	0.6			μs
t <sub>SU,STO</sub>	Set up time for stop condition	0.6			μs
t <sub>BUF</sub>	Bus free time between a stop and start condition	1.3			μs
t <sub>VD,DAT</sub>	Data valid time			0.9	μs
t <sub>VD,ACK</sub>	Data valid acknowledge time			0.9	μs
f <sub>SCL</sub>	SCL clock frequency; I <sup>2</sup> C mode for local I <sup>2</sup> C control			400	kHz
t <sub>r</sub>	Rise time of both SDA and SCL signals			300	ns
t <sub>f</sub>	Fall time of both SDA and SCL signals			300	ns
C <sub>BUS_100KHZ</sub>	Total capacitive load for each bus line when operating at ≤ 100 kHz			400	pF
C <sub>BUS_400KHZ</sub>	Total capacitive load for each bus line when operating at 400 kHz			100	pF

## 6.7 Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>CCCB_DEFAULT</sub>	Power on default of CC1 and CC2 voltage debounce time	DEBOUCE register = 2'b00		168		ms
t <sub>VBUS_DB</sub>	Debounce of VBUS_DET pin after valid V <sub>BUS,THR</sub>			2		ms
t <sub>DRP_DUTY_CYCLE</sub>	Power-on default of percentage of time DRP advertises DFP during a T <sub>DRP</sub>	DRP_DUTY_CYCLE register = 2'b00		30%		
t <sub>DRP</sub>	The period during which the TUSB320 in DFP mode completes a DFP to UFP and back advertisement.		50	75	100	ms
t <sub>I2C_EN</sub>	Time from TUSB320L's EN_N low or TUSB320H's EN high and V <sub>DD</sub> active to I <sup>2</sup> C access available				100	ms
t <sub>SOFT_RESET</sub>	Soft reset duration		26	49	95	ms

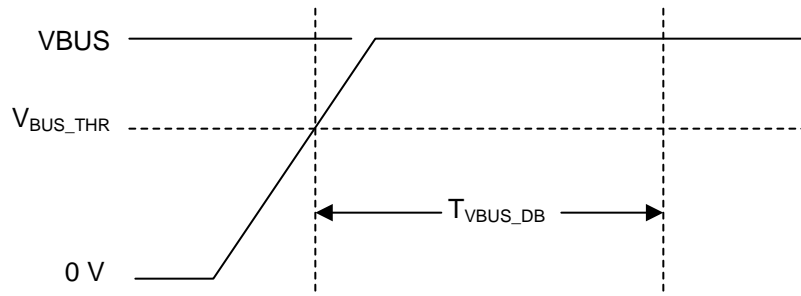
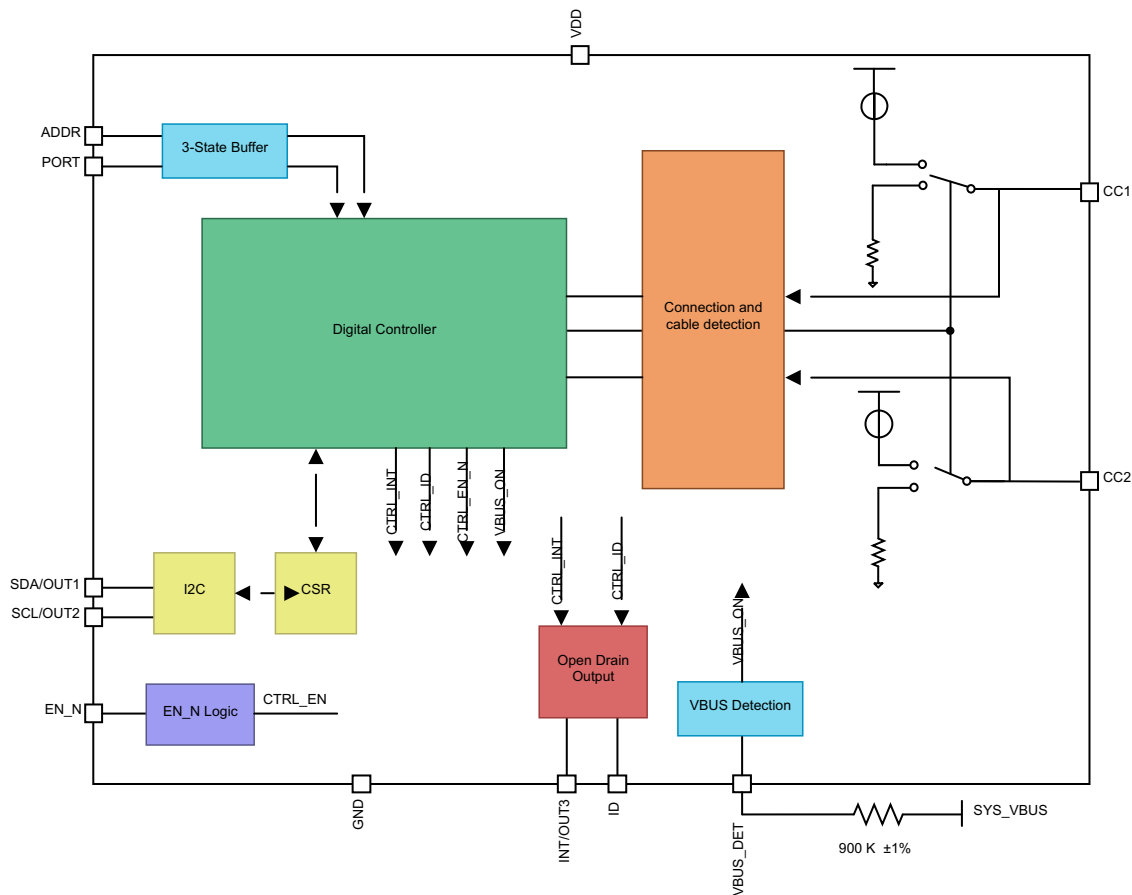


Figure 1. VBUS Detect and Debounce

## 7 Detailed Description

### 7.1 Overview

The USB Type-C ecosystem operates around a small form factor connector and cable that is flippable and reversible. Because of the nature of the connector, a scheme is needed to determine the connector orientation. Additional schemes are needed to determine when a USB port is attached and the acting role of the USB port (DFP, UFP, DRP), as well as to communicate Type-C current capabilities. These schemes are implemented over the CC pins according to the USB Type-C specifications. The TUSB320 devices provide Configuration Channel (CC) logic for determining USB port attach and detach, role detection, cable orientation, and Type-C current mode. The TUSB320 devices also contains several features such as mode configuration and low standby current which make these devices ideal for source or sinks in USB2.0 applications.



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**Figure 2. Functional Block Diagram of TUSB320**

#### 7.1.1 Cables, Adapters, and Direct Connect Devices

*Type-C Specification 1.1* defines several cables, plugs and receptacles to be used to attach ports. The TUSB320 device supports all cables, receptacles, and plugs. The TUSB320 device does not support e-marking.

##### 7.1.1.1 USB Type-C Receptacles and Plugs

Below is list of Type-C receptacles and plugs supported by the TUSB320 device:

- USB Type-C receptacle for USB2.0 platforms and devices
- USB full-featured Type-C plug
- USB2.0 Type-C plug



## Overview (continued)

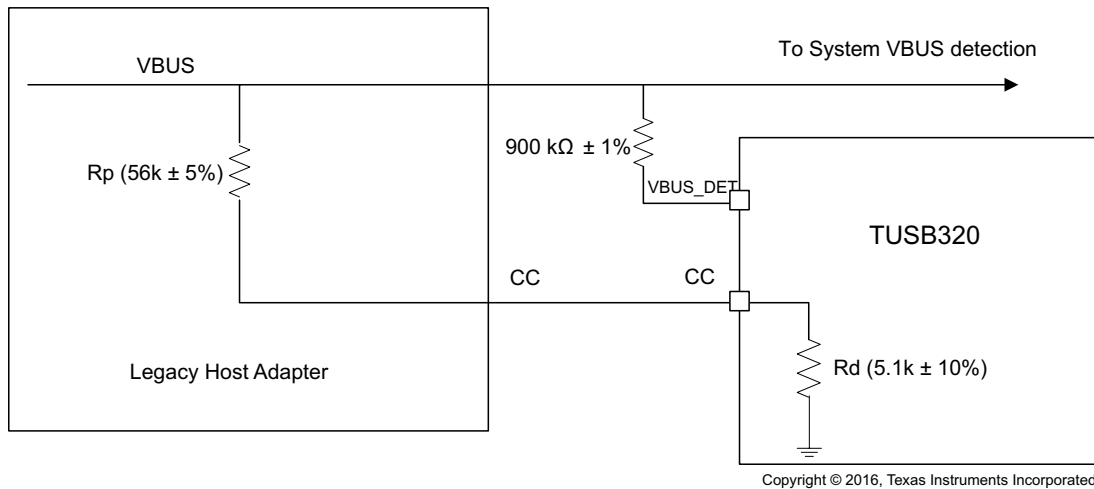
### 7.1.1.2 USB Type-C Cables

Below is a list of Type-C cables types supported by the TUSB320 device:

- USB full-featured Type-C cable
- USB2.0 Type-C cable with USB2.0 plug
- Captive cable on remote device with either a USB full-featured plug or USB2.0 plug

### 7.1.1.3 Legacy Cables and Adapters

The TUSB320 device supports legacy cable adapters as defined by the Type-C Specification. The cable adapter must correspond to the mode configuration of the TUSB320 device.



**Figure 3. Legacy Adapter Implementation Circuit**

### 7.1.1.4 Direct Connect Devices

The TUSB320 device supports the attaching and detaching of a direct-connect device.

### 7.1.1.5 Audio Adapters

Additionally, the TUSB320 device supports audio adapters for audio accessory mode, including:

- Passive Audio Adapter
- Charge Through Audio Adapter

## 7.2 Feature Description

### 7.2.1 Port Role Configuration

The TUSB320 device can be configured as a downstream facing port (DFP), upstream facing port (UFP), or dualrole port (DRP) using the tri-level PORT pin. The PORT pin should be pulled high to  $V_{DD}$  using a pullup resistance, low to GND or left as floated on the PCB to achieve the desired mode. This flexibility allows the TUSB320 device to be used in a variety of applications. The TUSB320 device samples the PORT pin after reset and maintains the desired mode until the TUSB320 device is reset again. The port role can also be selected through I<sup>2</sup>C registers. [Table 1](#) lists the supported features in each mode:

**Feature Description (continued)**
**Table 1. Supported Features for the TUSB320 Device by Mode**

PORT PIN	HIGH (DFP ONLY)	LOW (UFP ONLY)	NC (DRP)
<b>SUPPORTED FEATURES</b>			
Port attach and detach	Yes	Yes	Yes
Cable orientation (through I <sup>2</sup> C)	Yes	Yes	Yes
Current advertisement	Yes	-	Yes (DFP)
Current detection	-	Yes	Yes (UFP)
Accessory modes (audio and debug)	Yes	Yes	Yes
Try.SRC	-	-	Yes
Try.SNK	-	-	Yes
Active cable detection	Yes	-	Yes (DFP)
I <sup>2</sup> C / GPIO	Yes	Yes	Yes
Legacy cables	Yes	Yes	Yes
V <sub>BUS</sub> detection	-	Yes	Yes (UFP)

**7.2.1.1 Downstream Facing Port (DFP) - Source**

The TUSB320 device can be configured as a DFP only by pulling the PORT pin high through a resistance to V<sub>DD</sub>. In DFP mode, the TUSB320 device constantly presents R<sub>ps</sub> on both CC. In DFP mode, the TUSB320 device initially advertises default USB Type-C current. The Type-C current can be adjusted through I<sup>2</sup>C if the system needs to increase the amount advertised. The TUSB320 device adjusts the R<sub>ps</sub> to match the desired Type-C current advertisement. In GPIO mode, the TUSB320 device only advertises default Type-C current.

When configured as a DFP, the TUSB320 can operate with older USB Type-C 1.0 devices except for a USB Type-C 1.0 DRP device. A USB Type-C 1.1 compliant DFP can not connect to a Type-C 1.0 DRP. Because the TUSB320 is compliant to Type-C 1.1, the TUSB320 can not operate with a USB Type-C 1.0 DRP device. This limitation is a result of a backwards compatibility problem between USB Type-C 1.1 DFP and a USB Type-C 1.0 DRP.

**7.2.1.2 Upstream Facing Port (UFP) - Sink**

The TUSB320 device can be configured as a UFP only by pulling the PORT pin low to GND. In UFP mode, the TUSB320 device constantly presents pulldown resistors (R<sub>d</sub>) on both CC pins. The TUSB320 device monitors the CC pins for the voltage level corresponding to the Type-C mode current advertisement by the connected DFP. The TUSB320 device debounces the CC pins and wait for V<sub>BUS</sub> detection before successfully attaching. As a UFP, the TUSB320 device detects and communicates the advertised current level of the DFP to the system through the OUT1 and OUT2 GPIOs (if in GPIO mode) or through the I<sup>2</sup>C CURRENT\_MODE\_DETECT register one time in the Attached.SNK state.

**7.2.1.3 Dual Role Port (DRP)**

The TUSB320 device can be configured to operate as a DRP when the PORT pin is left floated on the PCB. In DRP mode, the TUSB320 device toggles between operating as a DFP and a UFP. When functioning as a DFP in DRP mode, the TUSB320 device complies with all operations as defined for a DFP according to the Type-C Specification. When presenting as a UFP in DRP mode, the TUSB320 device operates as defined for a UFP according to the Type-C Specification.

The TUSB320 supports two optional Type-C DRP features called Try.SRC and Try.SNK. Products supporting dual-role functionality may have a need to be a source (DFP) or a sink (UFP) when connected to another dual-role capable product. For example, a dual-role capable notebook may desire to be a source when connected to a tablet, or a cell phone would prefer to be a sink when connected to a notebook or tablet. When standard DRP products (products which don't support either Try.SRC or Try.SNK) are connected together, the role (UFP or DFP) outcome is not predetermined. These two optional DRP features provide a means for dual-role capable products to connect to another dual-role capable product in the role desired. Try.SRC and Try.SNK are only available when TUSB320 is configured in I<sup>2</sup>C mode. When operating in GPIO mode, the TUSB320 will always operate as a standard DRP.

The TUSB320's Try.SRC feature provides a means for a DRP product to connect as a DFP when connected to another DRP product that doesn't implement Try.SRC. When two products which implement Try.SRC are connected together, the role outcome of either UFP or DFP is the same as a standard DRP. Try.SRC is enabled by changing I<sup>2</sup>C register SOURCE\_PREF to 2'b11. Once this register is changed to 2'b11, the TUSB320 will always attempt to connect as a DFP when attached to another DRP capable device.

The TUSB320's Try.SNK feature provides a method for a DRP product to connect as a UFP when connected to another DRP product that doesn't implement Try.SNK. When two products which implement Try.SNK are connected together, the role outcome of either UFP or DFP is the same as a standard DRP. Try.SNK is enabled by changing I<sup>2</sup>C register SOURCE\_PREF to 2'b01. Once this register is changed to 2'b01, the TUSB320 will always attempt to connect as a UFP when attached to another DRP capable device.

## 7.2.2 Type-C Current Mode

When a valid cable detection and attach have been completed, the DFP has the option to advertise the level of Type-C current a UFP can sink. The default current advertisement for the TUSB320 device is max of 500 mA (for USB2.0) or max of 900 mA (for USB3.1). If a higher level of current is available, the I<sup>2</sup>C registers can be written to provide medium current at 1.5 A or high current at 3 A. When the CURRENT\_MODE\_ADVERTISE register has been written to advertise higher than default current, the DFP adjusts the Rps for the specified current level. If a DFP advertises 3 A, system designer must ensure that the V<sub>DD</sub> of the TUSB320 device is 3.5 V or greater. [Table 2](#) lists the Type-C current advertisements in GPIO and I<sup>2</sup>C modes.

**Table 2. Type-C Current Advertisement for GPIO and I<sup>2</sup>C Modes**

TYPE-C CURRENT		GPIO MODE (ADDR PIN IN NC)		I <sup>2</sup> C MODE (ADDR PIN H, L)	
		UFP (PORT PIN L)	DFP (PORT PIN H)	UFP	DFP
Default	max of 500 mA (USB2.0) max of 900 mA (USB3.1)	Current mode detected and output through OUT1 / OUT2	Only advertisement	Current mode detected and read through I <sup>2</sup> C register	I <sup>2</sup> C register default is 500 or 900 mA (max)
Medium - 1.5 A (max)	N/A		Advertisement selected through writing I <sup>2</sup> C register		
High - 3 A (max)					

## 7.2.3 Accessory Support

The TUSB320 device supports audio and debug accessories in UFP, DFP mode and DRP mode. Audio and debug accessory support is provided through reading of I<sup>2</sup>C registers. Audio accessory is also supported through GPIO mode with INT\_N/OUT3 pin (audio accessory is detected when INT\_N/OUT3 pin is low).

### 7.2.3.1 Audio Accessory

Audio accessory mode is supported through two types of adapters. First, the passive audio adapter can be used to convert the Type-C connector into an audio port. In order to effectively detect the passive audio adapter, the TUSB320 device must detect a resistance < R<sub>a</sub> on both of the CC pins.

Secondly, a charge through audio adapter may be used. The primary difference between a passive and charge through adapter is that the charge through adapter supplies 500 mA of current over V<sub>BUS</sub>. The charge through adapter contains a receptacle and a plug. The plug acts as a DFP and supply V<sub>BUS</sub> when the plug detects a connection.

When the TUSB320 device is configured in GPIO mode, OUT3 pin determines if an audio accessory is connected. When an audio accessory is detected, the OUT3 pin is pulled low.

### 7.2.3.2 Debug Accessory

Debug is an additional state supported by USB Type-C. The specification does not define a specific user scenario for this state, but it is important because the end user could use debug accessory mode to enter a test state for production specific to the application. Charge through debug accessory is not supported by TUSB320 when in DRP or UFP mode.

### 7.2.4 I<sup>2</sup>C and GPIO Control

The TUSB320 device can be configured for I<sup>2</sup>C communication or GPIO outputs using the ADDR pin. The ADDR pin is a tri-level control pin. When the ADDR pin is left floating (NC), the TUSB320 device is in GPIO output mode. When the ADDR pin is pulled high or pulled low, the TUSB320 device is in I<sup>2</sup>C mode.

All outputs for the TUSB320 device are open drain configuration.

The OUT1 and OUT2 pins are used to output the Type-C current mode when in GPIO mode. Additionally, the OUT3 pin is used to communicate the audio accessory mode in GPIO mode. [Table 3](#) lists the output pin settings. See for more information.

**Table 3. Simplified Operation for OUT1 and OUT2**

OUT1	OUT2	ADVERTISEMENT
H	H	Default Current in Unattached State
H	L	Default Current in Attached State
L	H	Medium Current (1.5 A) in Attached State
L	L	High Current (3.0 A) in Attached State

When operating in I<sup>2</sup>C mode, the TUSB320 device uses the SCL and SDA lines for clock and data and the INT\_N pin to communicate a change in I<sup>2</sup>C registers, or an interrupt, to the system. The INT\_N pin is pulled low when the TUSB320 device updates the registers with new information. The INT\_N pin is open drain. The INTERRUPT\_STATUS register will be set when the INT\_N pin is pulled low. To clear the INTERRUPT\_STATUS register, the end user writes to I<sup>2</sup>C.

When operating in GPIO mode, the OUT3 pin is used in place of the INT\_N pin to determine if an audio accessory is detected and attached. The OUT3 pin is pulled low when an audio accessory is detected.

#### NOTE

When using the 3.3 V supply for I<sup>2</sup>C, the end user must ensure that the V<sub>DD</sub> is 3 V and above. Otherwise the I<sup>2</sup>C may back power the device.

### 7.2.5 V<sub>BUS</sub> Detection

The TUSB320 device supports V<sub>BUS</sub> detection according to the Type-C Specification. V<sub>BUS</sub> detection is used to determine the attachment and detachment of a UFP and to determine the entering and exiting of accessory modes. V<sub>BUS</sub> detection is also used to successfully resolve the role in DRP mode.

The system V<sub>BUS</sub> voltage must be routed through a 900-kΩ resistor to the VBUS\_DET pin on the TUSB320 device if the PORT pin is configured as a DRP or a UFP. If the TUSB320 device is configured as a DFP and only ever used in DFP mode, the VBUS\_DET pin can be left unconnected.

### 7.3 Device Functional Modes

The TUSB320 device has four functional modes. [Table 4](#) lists these modes:

**Table 4. USB Type-C States According to TUSB320 Functional Modes**

MODES	GENERAL BEHAVIOR	PORT PIN	STATES <sup>(1)</sup>					
Unattached	USB port unattached. ID, PORT operational. I <sup>2</sup> C on. CC pins configure according to PORT pin.	UFP	Unattached.SNK					
			AttachWait.SNK					
		DRP	Toggle Unattached.SNK → Unattached.SRC					
			AttachedWait.SRC or AttachedWait.SNK					
		DFP	Unattached.SRC					
			AttachWait.SRC					
Active	USB port attached. All GPIOs operational. I <sup>2</sup> C on.	UFP	Attached.SNK					
			Audio accessory					
			Debug accessory					
		DRP	Attached.SNK					
			Attached.SRC					
			Audio accessory					
		DFP	Debug accessory					
			Attached.SRC					
			Audio accessory					
		Dead battery	No operation. V <sub>DD</sub> not available.	UFP/DRP/DFP	Default device state to UFP/SNK with Rd.			
					Shutdown	V <sub>DD</sub> available. TUSB320L's EN_N pin high. TUSB320H's EN pin low.	UFP/DRP/DFP	Default device state to UFP/SNK with Rd.

(1) Required; not in sequential order.

#### 7.3.1 Unattached Mode

Unattached mode is the primary mode of operation for the TUSB320 device, because a USB port can be unattached for a lengthy period of time. In unattached mode, V<sub>DD</sub> is available, and all IOs and I<sup>2</sup>C are operational. After the TUSB320 device is powered up, the part enters unattached mode until a successful attach has been determined. Initially, right after power up, the TUSB320 device comes up as an Unattached.SNK. The TUSB320 device checks the PORT pin and operates according to the mode configuration. The TUSB320 device toggles between the UFP and the DFP if configured as a DRP. In unattached mode, I<sup>2</sup>C can be used to change the mode configuration or port role if the board configuration of the PORT pin is not the desired mode. Writing to the I<sup>2</sup>C MODE\_SELECT register can override the PORT pin in unattached mode. The PORT pin is only sampled at reset (TUSB320L's EN\_N high to low transition or TUSB320H's EN low to high transition), after I2C\_SOFT\_RESET, or power up. I<sup>2</sup>C must be used after reset to change the device mode configuration.

### 7.3.2 Active Mode

Active mode is defined as the port being attached. In active mode, all GPIOs are operational, and I<sup>2</sup>C is read / write (R/W). When in active mode, the TUSB320 device communicates to the AP that the USB port is attached. This happens through the ID pin if TUSB320 is configured as a DFP or DRP connect as source. If TUSB320 is configured as a UFP or a DRP connected as a sink, the OUT1/OUT2 and INT\_N/OUT3 pins are used. The TUSB320 device exits active mode under the following conditions:

- Cable unplug
- V<sub>BUS</sub> removal if attached as a UFP
- Dead battery; system battery or supply is removed
- TUSB320L EN\_N pin floated or pulled high
- TUSB320H EN pin floated or pulled low.

During active mode, I<sup>2</sup>C be used to change the mode configuration. This can be done by following the sequence below. This same sequence is valid when TUSB320 is in unattached mode.

- Set DISABLE\_TERM register (address 0x0A bit 0) to a 1'b1.
- Change MODE\_SELECT register (address 0x0A bits 5:4) to desired mode of operation.
- Wait 5 ms.
- Clear DISABLE\_TERM register (address 0x0A bit 0) to 1'b0.

### 7.3.3 Dead Battery Mode

During dead battery mode, V<sub>DD</sub> is not available. CC pins always default to pulldown resistors in dead battery mode. Dead battery mode means:

- TUSB320 in UFP with 5.1-kΩ ± 20% Rd; cable connected and providing charge
- TUSB320 in UFP with 5.1-kΩ ± 20% Rd; nothing connected (application could be off or have a discharged battery)

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#### NOTE

When V<sub>DD</sub> is off, the TUSB320 non-failsafe pins (VBUS\_DET, ADDR, PORT, ID, OUT[3:1] pins) could back-drive the TUSB320 device if not handled properly. When necessary to pull these pins up, it is recommended to pullup PORT, ADDR, INT\_N/OUT3, and ID to the device's V<sub>DD</sub> supply. The VBUS\_DET must be pulled up to V<sub>BUS</sub> through a 900-kΩ resistor.

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### 7.3.4 Shutdown Mode

Shutdown mode for TUSB320L device is defined as follows:

- Supply voltage available and EN\_N pin is pulled high or floating.
- EN\_N pin has internal pullup resistor.
- The TUSB320L device is off, but still maintains the Rd on the CC pins

Shutdown mode for TUSB320H device is defined as follows:

- Supply voltage available and EN pin is pulled low or floating.
- EN pin has internal pulldown resistor.
- The TUSB320H device is off, but still maintains the Rd on the CC pins

## 7.4 Programming

For further programmability, the TUSB320 device can be controlled using I<sup>2</sup>C. The TUSB320 device local I<sup>2</sup>C interface is available for reading/writing after T<sub>I<sup>2</sup>C\_EN</sub> when the device is powered up. The SCL and SDA terminals are used for I<sup>2</sup>C clock and I<sup>2</sup>C data respectively. If I<sup>2</sup>C is the preferred method of control, the ADDR pin must be set accordingly.

**Table 5. TUSB320 I<sup>2</sup>C Addresses**

TUSB320 I <sup>2</sup> C Target Address								
ADDR pin	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (W/R)
H	1	1	0	0	1	1	1	0/1
L	1	0	0	0	1	1	1	0/1

The following procedure should be followed to write to TUSB320 I<sup>2</sup>C registers:

1. The master initiates a write operation by generating a start condition (S), followed by the TUSB320 7-bit address and a zero-value R/W bit to indicate a write cycle
2. The TUSB320 device acknowledges the address cycle
3. The master presents the sub-address (I<sup>2</sup>C register within the TUSB320 device) to be written, consisting of one byte of data, MSB-first
4. The TUSB320 device acknowledges the sub-address cycle
5. The master presents the first byte of data to be written to the I<sup>2</sup>C register
6. The TUSB320 device acknowledges the byte transfer
7. The master may continue presenting additional bytes of data to be written, with each byte transfer completing with an acknowledge from the TUSB320 device
8. The master terminates the write operation by generating a stop condition (P)

The following procedure should be followed to read the TUSB320 I<sup>2</sup>C registers:

1. The master initiates a read operation by generating a start condition (S), followed by the TUSB320 7-bit address and a one-value R/W bit to indicate a read cycle
2. The TUSB320 device acknowledges the address cycle
3. The TUSB320 device transmits the contents of the memory registers MSB-first starting at register 00h or last read sub-address+1. If a write to the T I<sup>2</sup>C register occurred prior to the read, then the TUSB320 device starts at the sub-address specified in the write.
4. The TUSB320 device waits for either an acknowledge (ACK) or a not-acknowledge (NACK) from the master after each byte transfer; the I<sup>2</sup>C master acknowledges reception of each data byte transfer
5. If an ACK is received, the TUSB320 device transmits the next byte of data
6. The master terminates the read operation by generating a stop condition (P)

The following procedure should be followed for setting a starting sub-address for I<sup>2</sup>C reads:

1. The master initiates a write operation by generating a start condition (S), followed by the TUSB320 7-bit address and a zero-value R/W bit to indicate a read cycle
2. The TUSB320 device acknowledges the address cycle
3. The master presents the sub-address (I<sup>2</sup>C register within the TUSB320 device) to be read, consisting of one byte of data, MSB-first
4. The TUSB320 device acknowledges the sub-address cycle
5. The master terminates the read operation by generating a stop condition (P)

### NOTE

If no sub-addressing is included for the read procedure, then the reads start at register offset 00h and continue byte-by-byte through the registers until the I<sup>2</sup>C master terminates the read operation. If a I<sup>2</sup>C address write occurred prior to the read, then the reads start at the sub-address specified by the address write.



## 7.5 Register Maps

**Table 6. CSR Registers**

ACCESS TAG	NAME	MEANING
R	Read	The field may be read by software.
W	Write	The field may be written by software.
S	Set	The field may be set by a write of one. Writes of zeros to the field have no effect.
C	Clear	The field may be cleared by a write of one. Writes of zeros to the field have no effect.
U	Update	Hardware may autonomously update this field.
NA	No Access	Not accessible or not applicable.

### 7.5.1 CSR Registers (address = 0x00 – 0x07)

**Figure 4. CSR Registers (address = 0x00 – 0x07)**

7	6	5	4	3	2	1	0
DEVICE_ID							
R							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 7. CSR Registers (address = 0x00 – 0x07)**

Bit	Field	Type	Reset	Description
7:0	DEVICE_ID	R		For the TUSB320 device these fields return a string of ASCII characters returning TUSB320 Addresses 0x07 - 0x00 = {0x00 0x54 0x55 0x53 0x42 0x33 0x32 0x30}



## 7.5.2 CSR Registers (address = 0x08)

**Figure 5. CSR Registers (address = 0x08)**

7	6	5	4	3	2	1	0
CURRENT_MODE_ADVERTISE		CURRENT_MODE_DETECT		ACCESSORY_CONNECTED			ACTIVE_CABLE_DETECTION
RW		RU		RU			RU

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 8. CSR Registers (address = 0x08)**

Bit	Field	Type	Reset	Description
7:6	CURRENT_MODE_ADVERTISE	RW	00	These bits are programmed by the application to raise the current advertisement from default. 00 – Default (500 mA / 900 mA) initial value at startup 01 – Mid (1.5 A) 10 – High (3 A) 11 – Reserved
5:4	CURRENT_MODE_DETECT	RU	00	These bits are set when a UFP determines the Type-C Current mode. 00 – Default (value at start up) 01 – Medium 10 – Charge through accessory – 500 mA 11 – High
3:1	ACCESSORY_CONNECTED	RU	000	These bits are read by the application to determine if an accessory was attached. 000 – No accessory attached (default) 001 – Reserved 010 – Reserved 011 – Reserved 100 – Audio accessory 101 – Audio charged thru accessory 110 – Debug accessory when TUSB320 is connected as a DFP. 111 – Debug accessory when TUSB320 is connected as a UFP.
0	ACTIVE_CABLE_DETECTION	RU	0	This flag indicates that an active cable has been plugged into the Type-C connector. When this field is set, an active cable is detected.

**7.5.3 CSR Registers (address = 0x09)**
**Figure 6. CSR Registers (address = 0x09)**

7	6	5	4	3	2	1	0
ATTACHED_STATE	CABLE_DIR	INTERRUPT_STATUS	—	DRP_DUTY_CYCLE	DISABLE_UFP_ACCESSORY		
RU	RU	RCU	R	RW	RW		

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 9. CSR Registers (address = 0x09)**

Bit	Field	Type	Reset	Description
7:6	ATTACHED_STATE	RU	00	This is an additional method to communicate attach other than the ID pin. These bits can be read by the application to determine what was attached. 00 – Not attached (default) 01 – Attached.SRC (DFP) 10 – Attached.SNK (UFP) 11 – Attached to an accessory
5	CABLE_DIR	RU	1	Cable orientation. The application can read these bits for cable orientation information. 0 – CC1 1 – CC2 (default)
4	INTERRUPT_STATUS	RCU	0	The INT pin is pulled low whenever a CSR with RU in Access field changes. When a CSR change has occurred this bit should be held at 1 until the application clears it. A write of 1'b1 is required to clear this field. 0 – Clear 1 – Interrupt (When INT_N is pulled low, this bit will be 1. ) Note: SW must make sure the INTERRUPT_STATUS has been cleared to zero. Rewrites to this register are needed for the INT_N to be correctly asserted for all interrupt events.
3	Reserved	R	0	Reserved
2:1	DRP_DUTY_CYCLE	RW	00	Percentage of time that a DRP advertises DFP during tDRP 00 – 30% (default) 01 – 40% 10 – 50% 11 – 60%
0	DISABLE_UFP_ACCESSORY	RW	0	Settings this field will disable UFP accessory support. 0 – UFP accessory support enabled (Default) 1 – UFP accessory support disabled

**7.5.4 CSR Registers (address = 0x0A)**
**Figure 7. CSR Registers (address = 0x0A)**

7	6	5	4	3	2	1	0
DEBOUNCE		MODE_SELECT		I <sup>2</sup> C_SOFT_RESET	SOURCE_PREF	DISABLE_TERM	
RW		RW		RSU	RW	RW	

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 10. CSR Registers (address = 0x0A)**

Bit	Field	Type	Reset	Description
7:6	DEBOUNCE	RW	00	The nominal amount of time the TUSB320 device debounces the voltages on the CC pins. 00 – 168ms (default) 01 – 118ms 10 – 134ms 11 – 152ms
5:4	MODE_SELECT	RW	00	This register can be written to set the TUSB320 device mode operation. The ADDR pin must be set to I <sup>2</sup> C mode. If the default is maintained, the TUSB320 device operates according to the PORT pin levels and modes. 00 – Maintain mode according to PORT pin selection (default) 01 – UFP mode (unattached.SNK) 10 – DFP mode(unattached.SRC) 11 – DRP mode(start from unattached.SNK)
3	I <sup>2</sup> C_SOFT_RESET	RSU	0	This resets the digital logic. The bit is self-clearing. A write of 1 starts the reset. The following registers maybe affected after setting this bit: CURRENT_MODE_DETECT ACTIVE_CABLE_DETECTION ACCESSORY_CONNECTED ATTACHED_STATE CABLE_DIR
2:1	SOURCE_PREF	RW	00	This field controls the TUSB320 behavior when configured as a DRP. 00 – Standard DRP (default) 01 – DRP will perform Try.SNK. 10 – Reserved. 11 – DRP will perform Try.SRC.
0	DISABLE_TERM	RW	0	This field will disable the termination on the CC pins and transition the TUSB320's CC state machine to the Disable State. 0 – Termination enabled according to Port (Default) 1 – Termination disabled and state machine held in Disabled state.

**7.5.5 CSR Registers (address = 0x45)**
**Figure 8. CSR Registers (address = 0x45)**

7	6	5	4	3	2	1	0
		—	DISABLE_RD_RP			—	
		R	RW			RW	

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 11. CSR Registers (address = 0x45)**

Bit	Field	Type	Reset	Description
7:3	Reserved	R	00000	Reserved
2	DISABLE_RD_RP	RW	0	When this field is set, Rd and Rp are disabled. 0 – Normal operation (default) 1 – Disable Rd and Rp
1:0	Reserved	RW	00	For TI internal use only. Do not change default value.

**7.5.6 CSR Registers (address = 0xA0)**
**Figure 9. CSR Registers (address = 0xA0)**

7	6	5	4	3	2	1	0
REVISION							
R							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 12. CSR Registers (address = 0xA0)**

Bit	Field	Type	Reset	Description
7:0	REVISION	R	0x01	Revision of TUSB320. Defaults to 0x01.

## 8 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

The TUSB320 device is a Type-C configuration channel logic and port controller. The TUSB320 device can detect when a Type-C device is attached, what type of device is attached, the orientation of the cable, and power capabilities (both detection and broadcast). The TUSB320 device can be used in a source application (DFP), in a sink application (UFP), or a combination source/sink application (DRP).

### 8.2 Typical Application

#### 8.2.1 DRP in I<sup>2</sup>C Mode

Figure 10 and Figure 11 show a Type-C configuration for the DRP mode.

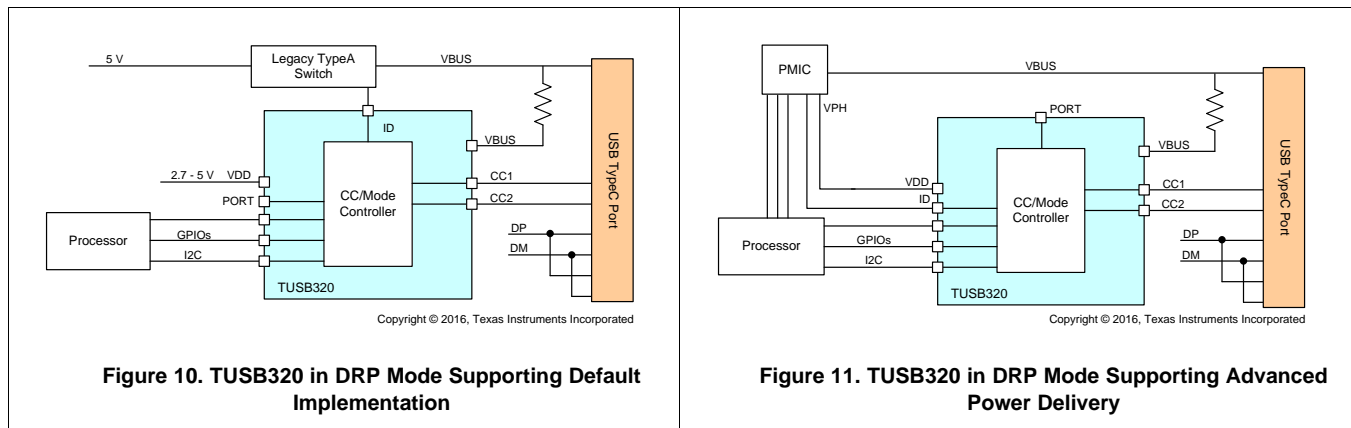


Figure 12 shows the TUSB320 device configured as a DRP in I<sup>2</sup>C mode.

Typical Application (continued)

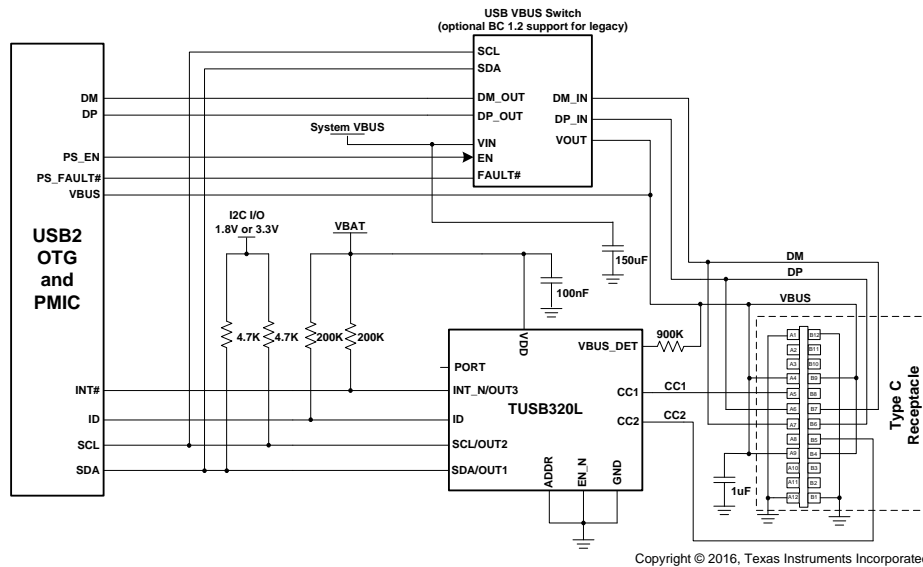


Figure 12. DRP in I<sup>2</sup>C Mode Schematic

8.2.1.1 Design Requirements

For this design example, use the parameters listed in Table 13:

Table 13. Design Requirements for DRP in I<sup>2</sup>C Mode

DESIGN PARAMETER	VALUE
V <sub>DD</sub> (2.75 V to 5 V)	VBAT (less than 5 V)
Mode (I <sup>2</sup> C or GPIO)	I <sup>2</sup> C: ADDR pin must be pulled down or pulled up
I <sup>2</sup> C address (0x67 or 0x47)	0x47: ADDR pin must be pulled low or tied to GND
Type-C port type (UFP, DFP, or DRP)	DRP: PORT pin is NC
Shutdown support	No

8.2.1.2 Detailed Design Procedure

The TUSB320 device supports a V<sub>DD</sub> in the range of 2.75 V to 5 V. In this particular use case, VBAT which must be in the required V<sub>DD</sub> range is connected to the V<sub>DD</sub> pin. A 100-nF capacitor is placed near V<sub>DD</sub>.

The TUSB320 device is placed into I<sup>2</sup>C mode by either pulling the ADDR pin high or low. In this case, the ADDR pin is tied to GND which results in a I<sup>2</sup>C address of 0x47. The SDA and SCL must be pulled up to either 1.8 V or 3.3 V. When pulled up to 3.3 V, the V<sub>DD</sub> supply must be at least 3 V to keep from back-driving the I<sup>2</sup>C interface.

The TUSB320L device can enter shutdown mode by pulling the EN\_N pin high, which puts the TUSB320L device into a low power state. In this case, external control of the EN\_N pin is not implemented and therefore the EN\_N pin is tied to GND. The TUSB320H device can enter shutdown mode by pulling the EN pin low, which puts the TUSB320H device into a low power state. In this case, external control of the EN pin is not implemented and therefore the EN pin is tied to 1.8V or 3.3V.

The INT\_N/OUT3 pin is used to notify the PMIC when a change in the TUSB320 I<sup>2</sup>C registers occurs. This pin is an open drain output and requires an external pullup resistor. The pin should be pulled up to V<sub>DD</sub> using a 200-kΩ resistor.

The ID pin is used to indicate when a connection has occurred if the TUSB320 device is a DFP while configured for DRP. An OTG USB controller can use this pin to determine when to operate as a USB Host or USB Device. When this pin is driven low, the OTG USB controller functions as a host and then enables  $V_{BUS}$ . The Type-C standard requires that a DFP not enable  $V_{BUS}$  until it is in the Attached.SRC state. If the ID pin is not low but  $V_{BUS}$  is detected, then OTG USB controller functions as a device. The ID pin is open drain output and requires an external pullup resistor. It should be pulled up to  $V_{DD}$  using a 200-k $\Omega$  resistor.

The Type-C port mode is determined by the state of the PORT pin. When the PORT pin is not connected, the TUSB320 device is in DRP mode. The Type-C port mode can also be controlled by the MODE\_SELECT register through the I<sup>2</sup>C interface.

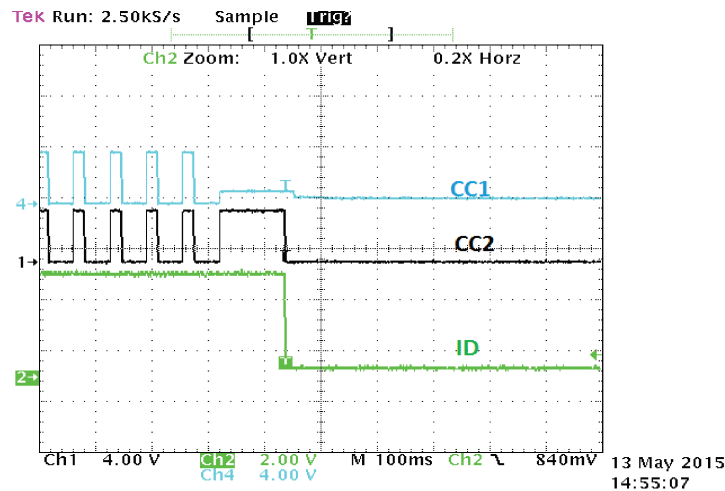
The VBUS\_DET pin must be connected through a 900-k $\Omega$  resistor to  $V_{BUS}$  on the Type-C that is connected. This large resistor is required to protect the TUSB320 device from large  $V_{BUS}$  voltage that is possible in present day systems. This resistor along with internal pulldown keeps the voltage observed by the TUSB320 device in the recommended range.

The USB2 specification requires the bulk capacitance on  $V_{BUS}$  based on UFP or DFP. When operating the TUSB320 device in a DRP mode, it alternates between UFP and DFP. If the TUSB320 device connects as a UFP, the large bulk capacitance must be removed.

**Table 14. USB2 Bulk Capacitance Requirements**

PORT CONFIGURATION	MIN	MAX	UNIT
Downstream facing port (DFP)	120		$\mu$ F
Upstream facing port (UFP)	1	10	$\mu$ F

### 8.2.1.3 Application Curves



**Figure 13. Application Curve for DRP in I<sup>2</sup>C Mode**

# TUSB320HI, TUSB320LI

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## 8.2.2 DFP in I<sup>2</sup>C Mode

Figure 14 and Figure 15 show a Type-C configuration for the DFP mode.

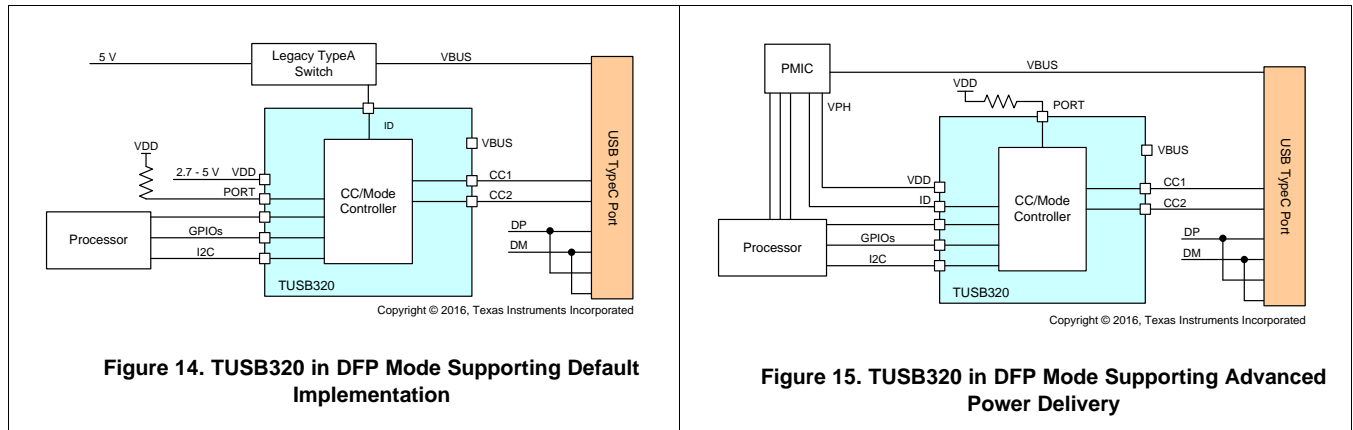


Figure 16 shows the TUSB320 device configured as a DFP in I<sup>2</sup>C mode.

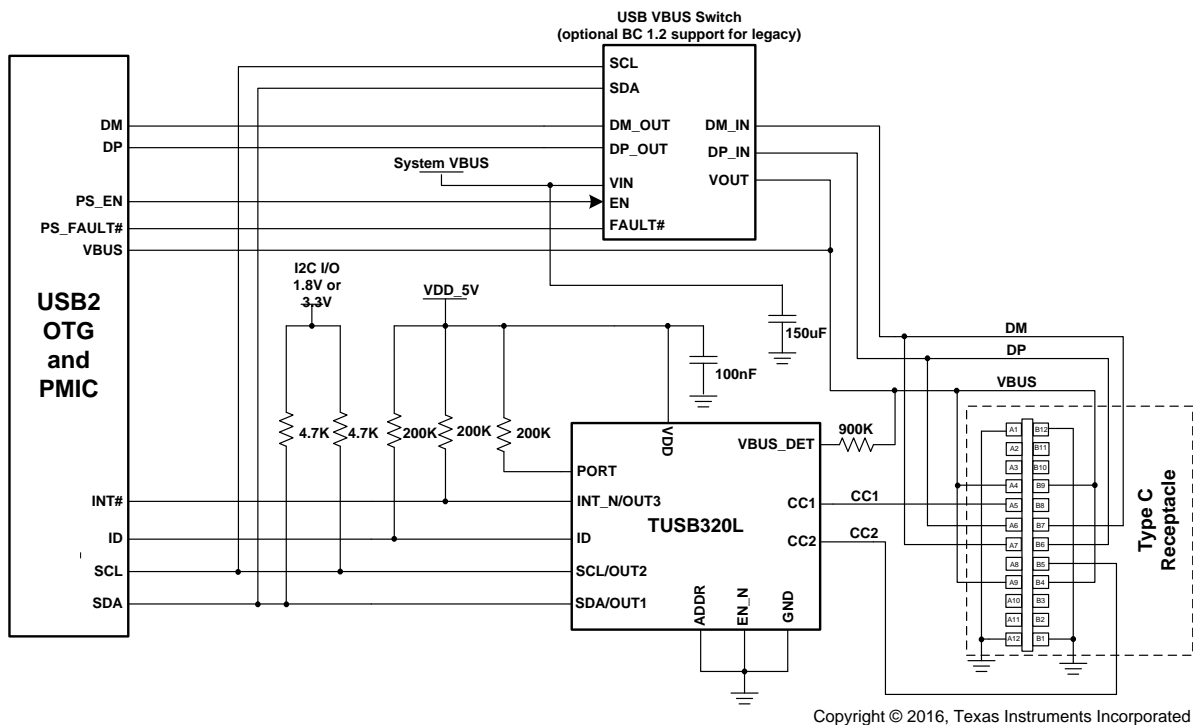


Figure 16. DFP in I<sup>2</sup>C Mode Schematic



### 8.2.2.1 Design Requirements

For this design example, use the parameters listed in [Table 15](#):

**Table 15. Design Requirements for DFP in I<sup>2</sup>C Mode**

DESIGN PARAMETER	VALUE
V <sub>DD</sub> (2.75 V to 5 V)	5 V
Mode (I <sup>2</sup> C or GPIO)	I <sup>2</sup> C: ADDR pin must be pulled down or pulled up
I <sup>2</sup> C address (0x67 or 0x47)	0x47: ADDR pin must be pulled low or tied to GND
Type-C port type (UFP, DFP, or DRP)	DFP: PORT pin is pulled up
Shutdown support	No

### 8.2.2.2 Detailed Design Procedure

The TUSB320 device supports a V<sub>DD</sub> in the range of 2.75 V to 5 V. In this particular case, V<sub>DD</sub> is set to 5 V. A 100-nF capacitor is placed near V<sub>DD</sub>.

The TUSB320 device is placed into I<sup>2</sup>C mode by either pulling the ADDR pin high or low. In this particular case, the ADDR pin is tied to GND which results in a I<sup>2</sup>C address of 0x47. The SDA and SCL must be pulled up to either 1.8 V or 3.3 V. When pulled up to 3.3 V, the V<sub>DD</sub> supply must be at least 3 V to keep from back-driving the I<sup>2</sup>C interface.

The TUSB320L device can enter shutdown mode by pulling the EN\_N pin high, which puts the TUSB320L device into a low power state. In this case, external control of the EN\_N pin is not implemented and therefore the EN\_N pin is tied to GND. The TUSB320H device can enter shutdown mode by pulling the EN pin low, which puts the TUSB320H device into a low power state. In this case, external control of the EN pin is not implemented and therefore the EN pin is tied to 1.8V or 3.3V.

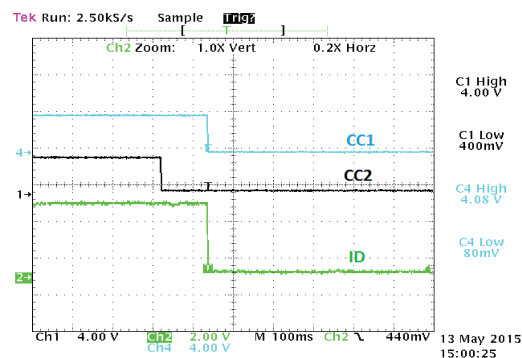
The INT\_N/OUT3 pin is used to notify the PMIC when a change in the TUSB320 I<sup>2</sup>C registers occurs. This pin is an open drain output and requires an external pullup resistor. The pin should be pulled up to V<sub>DD</sub> using a 200-kΩ resistor.

The Type-C port mode is determined by the state of the PORT pin. When the PORT pin is pulled high, the TUSB320 device is in DFP mode. The Type-C port mode can also be controlled by the MODE\_SELECT register through the I<sup>2</sup>C interface.

The VBUS\_DET pin must be connected through a 900-kΩ resistor to V<sub>BUS</sub> on the Type-C that is connected. This large resistor is required to protect the TUSB320 device from large V<sub>BUS</sub> voltage that is possible in present day systems. This resistor along with internal pulldown keeps the voltage observed by the TUSB320 device in the recommended range.

The USB2 specification requires the bulk capacitance on V<sub>BUS</sub> based on UFP or DFP. When operating the TUSB320 device in a DFP mode, a bulk capacitance of at least 120μF is required. In this particular case, a 150-μF capacitor was chosen.

### 8.2.2.3 Application Curves



**Figure 17. Application Curve for DFP in I<sup>2</sup>C Mode**

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8.2.3 UFP in I<sup>2</sup>C Mode

Figure 18 and Figure 19 show a Type-C configuration for the UFP mode.

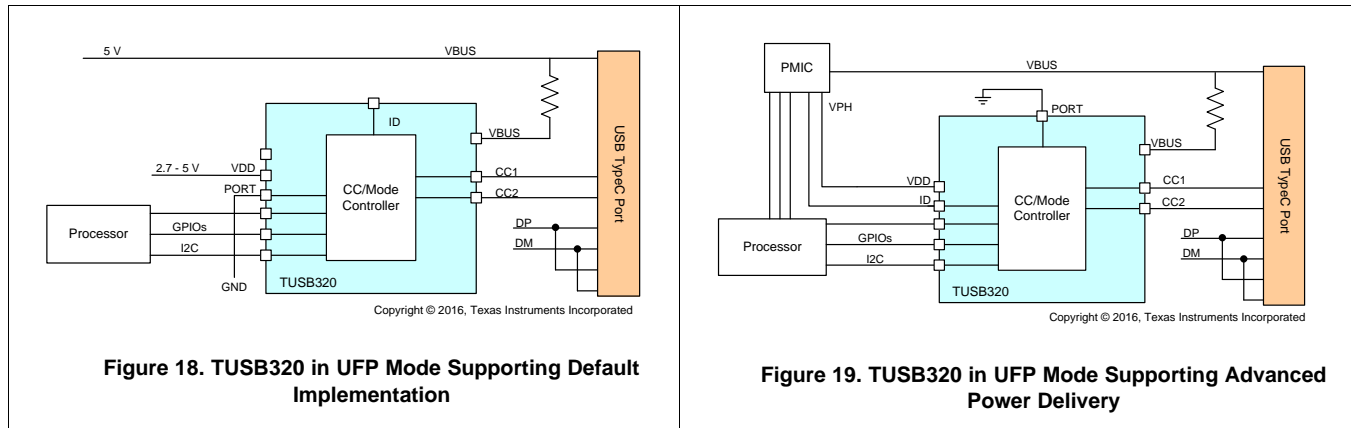
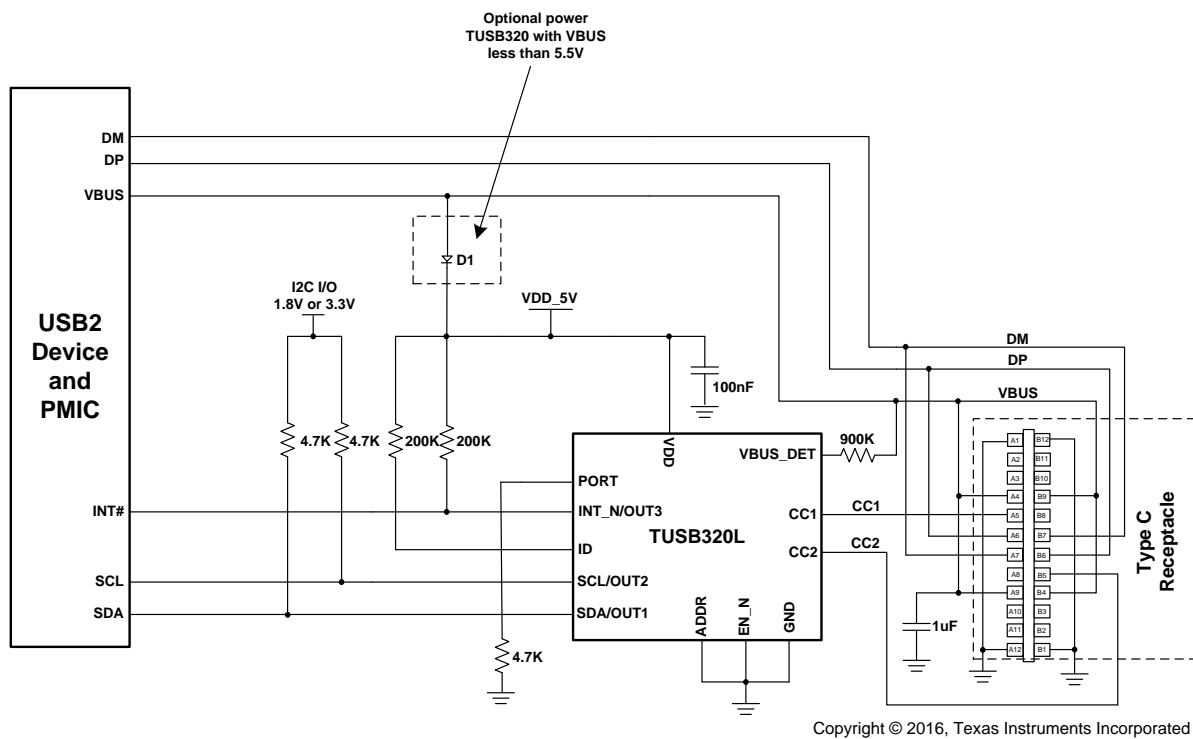


Figure 20 shows the TUSB320 device configured as a UFP in I<sup>2</sup>C mode.



### 8.2.3.1 Design Requirements

For this design example, use the parameters listed in Table 16:

Table 16. Design Requirements for UFP in I<sup>2</sup>C Mode

DESIGN PARAMETER	VALUE
V <sub>DD</sub> (2.75 V to 5 V)	5 V
Mode (I <sup>2</sup> C or GPIO)	I <sup>2</sup> C: ADDR pin must be pulled down or pulled up
I <sup>2</sup> C address (0x67 or 0x47)	0x47: ADDR pin must be pulled low or tied to GND
Type-C port type (UFP, DFP, or DRP)	UFP: PORT pin is pulled down
Shutdown support	No

### 8.2.3.2 Detailed Design Procedure

The TUSB320 device supports a V<sub>DD</sub> in the range of 2.75 V to 5 V. In this particular case, V<sub>DD</sub> is set to 5 V. A 100-nF capacitor is placed near V<sub>DD</sub>. If V<sub>BUS</sub> is guaranteed to be less than 5.5 V, powering the TUSB320 device through a diode can be implemented.

The TUSB320 device is placed into I<sup>2</sup>C mode by either pulling the ADDR pin high or low. In this case, the ADDR pin is tied to GND which results in a I<sup>2</sup>C address of 0x47. The SDA and SCL must be pulled up to either 1.8 V or 3.3 V. When pulled up to 3.3 V, the V<sub>DD</sub> supply must be at least 3 V to keep from back-driving the I<sup>2</sup>C interface.

The TUSB320L device can enter shutdown mode by pulling the EN\_N pin high, which puts the TUSB320L device into a low power state. In this case, external control of the EN\_N pin is not implemented and therefore the EN\_N pin is tied to GND. The TUSB320H device can enter shutdown mode by pulling the EN pin low, which puts the TUSB320H device into a low power state. In this case, external control of the EN pin is not implemented and therefore the EN pin is tied to 1.8V or 3.3V.

The INT\_N/OUT3 pin is used to notify the PMIC when a change in the TUSB320 I<sup>2</sup>C registers occurs. This pin is an open drain output and requires an external pullup resistor. The pin should be pulled up to V<sub>DD</sub> using a 200-kΩ resistor.

The Type-C port mode is determined by the state of the PORT pin. When the PORT pin is pulled low, the TUSB320 device is in UFP mode. The Type-C port mode can also be controlled by the MODE\_SELECT register through the I<sup>2</sup>C interface.

The VBUS\_DET pin must be connected through a 900-kΩ resistor to V<sub>BUS</sub> on the Type-C that is connected. This large resistor is required to protect the TUSB320 device from large V<sub>BUS</sub> voltage that is possible in present day systems. This resistor along with internal pulldown keeps the voltage observed by the TUSB320 device in the recommended range.

The USB2 specification requires the bulk capacitance on V<sub>BUS</sub> based on UFP or DFP. When operating the TUSB320 device in a UFP mode, a bulk capacitance between 1 to 10μF is required. In this particular case, a 1-μF capacitor was chosen.

### 8.2.3.3 Application Curves

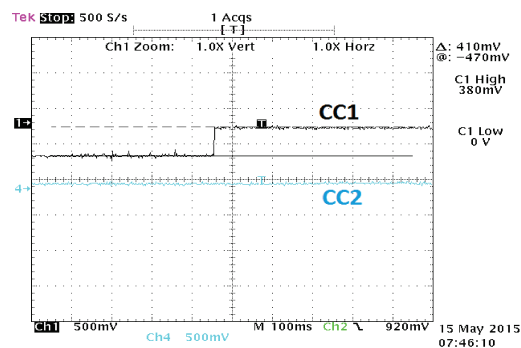


Figure 21. Application Curve for UFP in I<sup>2</sup>C Mode

## 8.3 Initialization Set Up

### 8.3.1 TUSB320L Initialization Procedure

The general power-up sequence for the TUSB320L device (EN\_N tied to ground) is as follows:

1. System is powered off (device has no  $V_{DD}$ ). The TUSB320L device is configured internally in UFP mode with Rds on CC pins (dead battery).
2.  $V_{DD}$  ramps – POR circuit.  $V_{DD}$  must ramp within 25 ms or less. IO pull-up power rail (i.e. pull up on ID, INT, SCL, SDA, ADDR, PORT) must ramp with  $V_{DD}$  or lag after  $V_{DD}$ .
3. I<sup>2</sup>C supply ramps up.
4. The TUSB320L device enters unattached mode and determines the voltage level from the PORT pin. This determines the mode in which the TUSB320L device operates (DFP, UFP, DRP).
5. The TUSB320L device monitors the CC pins as a DFP and  $V_{BUS}$  for attach as a UFP.
6. The TUSB320L device enters active mode when attach has been successfully detected.

### 8.3.2 TUSB320H Initialization Procedure

The general power-up sequence for the TUSB320H device (EN tied to 1.8V or 3.3V) is as follows:

1. System is powered off (device has no  $V_{DD}$ ). The TUSB320H device is configured internally in UFP mode with Rds on CC pins (dead battery).
2.  $V_{DD}$  ramps – POR circuit.  $V_{DD}$  must ramp within 25 ms or less. IO pull-up power rail (i.e. pull up on ID, INT, SCL, SDA, ADDR, PORT) must ramp with  $V_{DD}$  or lag after  $V_{DD}$ .
3. I<sup>2</sup>C supply ramps up.
4. The TUSB320H device enters unattached mode and determines the voltage level from the PORT pin. This determines the mode in which the TUSB320H device operates (DFP, UFP, DRP).
5. The TUSB320H device monitors the CC pins as a DFP and  $V_{BUS}$  for attach as a UFP.
6. The TUSB320H device enters active mode when attach has been successfully detected.

## 9 Power Supply Recommendations

The TUSB320 device has a wide power supply range from 2.7 to 5 V. The TUSB320 device can be run off of a system power such as a battery.

## 10 Layout

### 10.1 Layout Guidelines

1. An extra trace (or stub) is created when connecting between more than two points. A trace connecting pin A6 to pin B6 will create a stub because the trace also has to go to the USB Host. Ensure that:
  - A stub created by short on pin A6 (DP) and pin B6 (DP) at Type-C receptacle does not exceed 3.5 mm.
  - A stub created by short on pin A7 (DM) and pin B7 (DM) at Type-C receptacle does not exceed 3.5 mm.
2. A 100-nF capacitor should be placed as close as possible to the TUSB320  $V_{DD}$  pin.

### 10.2 Layout Example

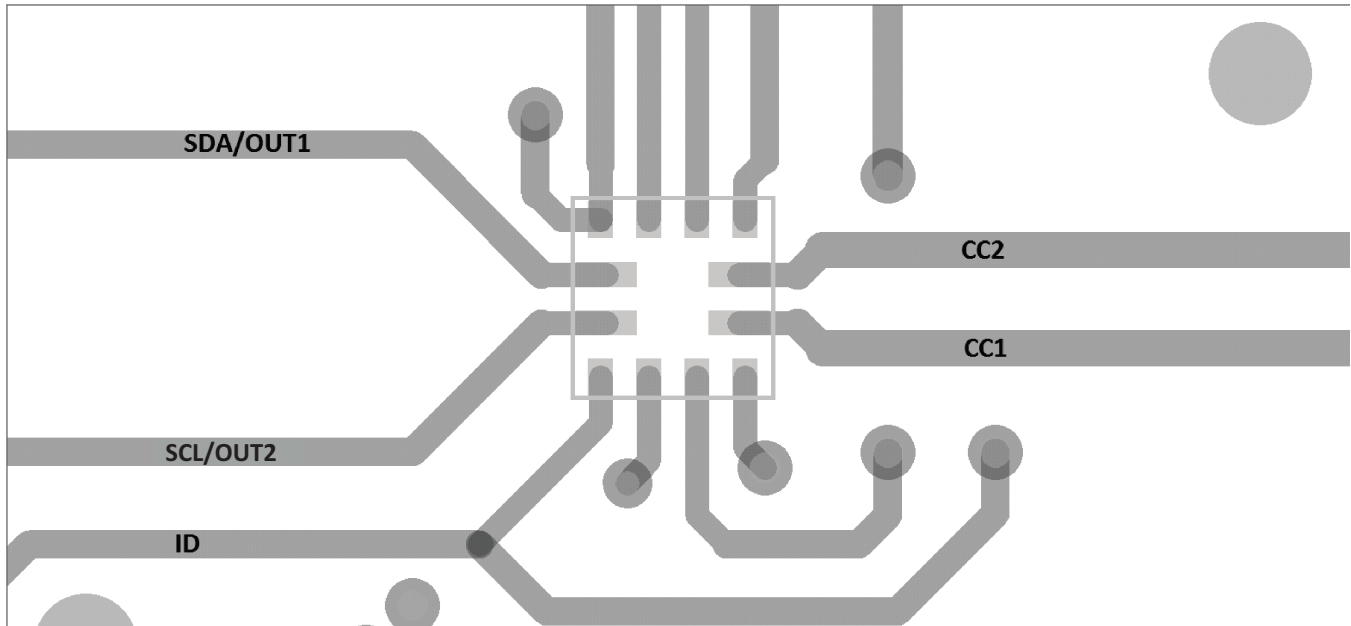


Figure 22. TUSB320 Layout

## 11 器件和文档支持

### 11.1 相关链接

下面的表格列出了快速访问链接。类别包括技术文档、支持与社区资源、工具和软件，以及申请样片或购买产品的快速链接。

表 17. 相关链接

器件	产品文件夹	样片与购买	技术文档	工具和软件	支持和社区
TUSB320HI	<a href="#">请单击此处</a>	<a href="#">请单击此处</a>	<a href="#">请单击此处</a>	<a href="#">请单击此处</a>	<a href="#">请单击此处</a>
TUSB320LI	<a href="#">请单击此处</a>	<a href="#">请单击此处</a>	<a href="#">请单击此处</a>	<a href="#">请单击此处</a>	<a href="#">请单击此处</a>

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### 11.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 机械、封装和可订购信息

以下页面包括机械、封装和可订购信息。这些信息是指定器件的最新可用数据。这些数据发生变化时，我们可能不会另行通知或修订此文档。如欲获取此产品说明书的浏览器版本，请参见左侧的导航栏。

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">TUSB320HIRWBR</a>	Active	Production	X2QFN (RWB)   12	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	5H
TUSB320HIRWBR.A	Active	Production	X2QFN (RWB)   12	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	5H
<a href="#">TUSB320LIRWBR</a>	Active	Production	X2QFN (RWB)   12	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	5L
TUSB320LIRWBR.A	Active	Production	X2QFN (RWB)   12	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	5L

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

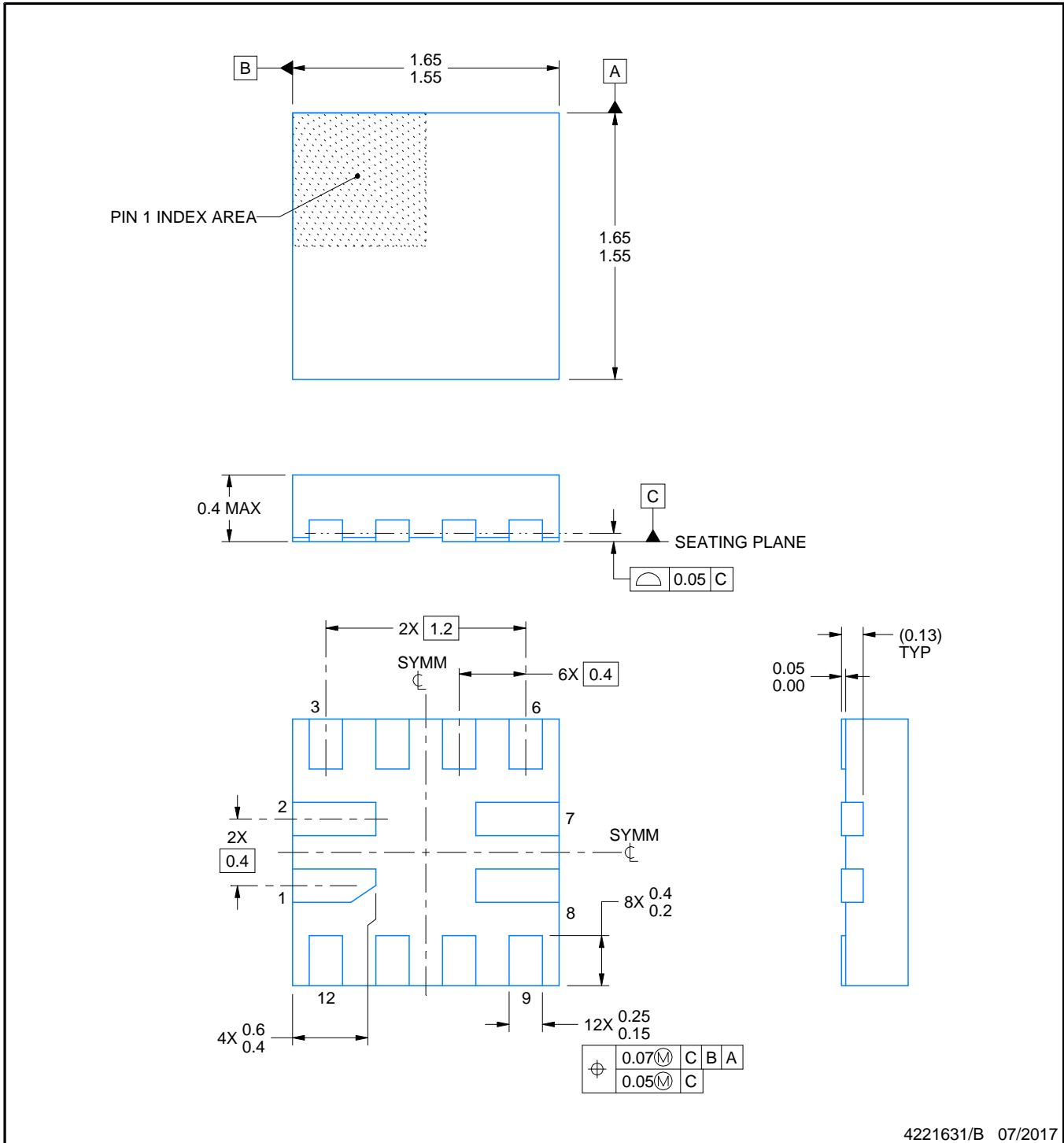
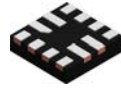
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TUSB320HIRWBR	X2QFN	RWB	12	3000	180.0	8.4	1.8	1.8	0.48	4.0	8.0	Q2
TUSB320LIRWBR	X2QFN	RWB	12	3000	180.0	8.4	1.8	1.8	0.48	4.0	8.0	Q2



**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TUSB320HIRWBR	X2QFN	RWB	12	3000	210.0	185.0	35.0
TUSB320LIRWBR	X2QFN	RWB	12	3000	210.0	185.0	35.0



4221631/B 07/2017

NOTES:

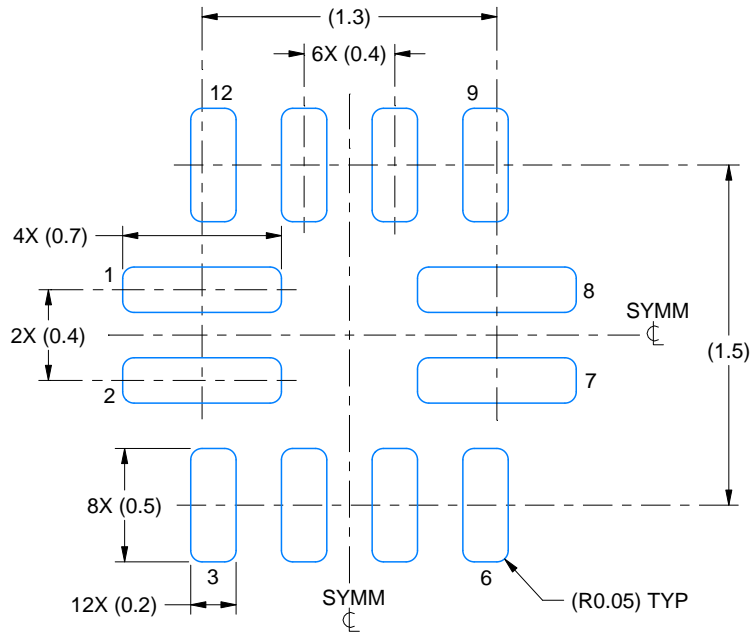
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

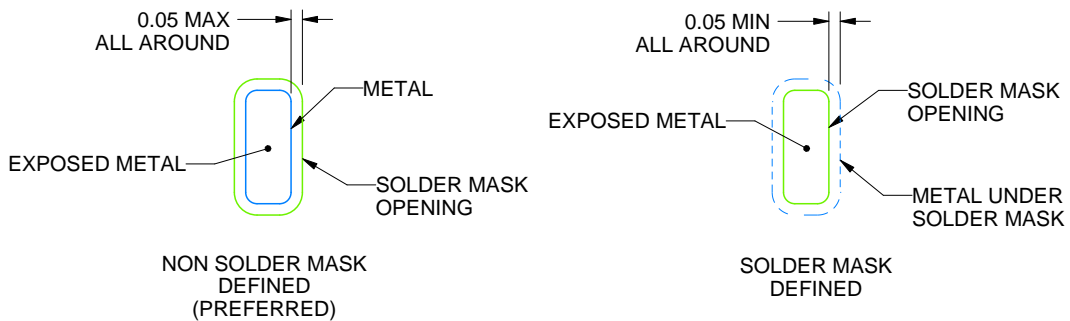
RWB0012A

X2QFN - 0.4 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:30X



SOLDER MASK DETAILS

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NOTES: (continued)

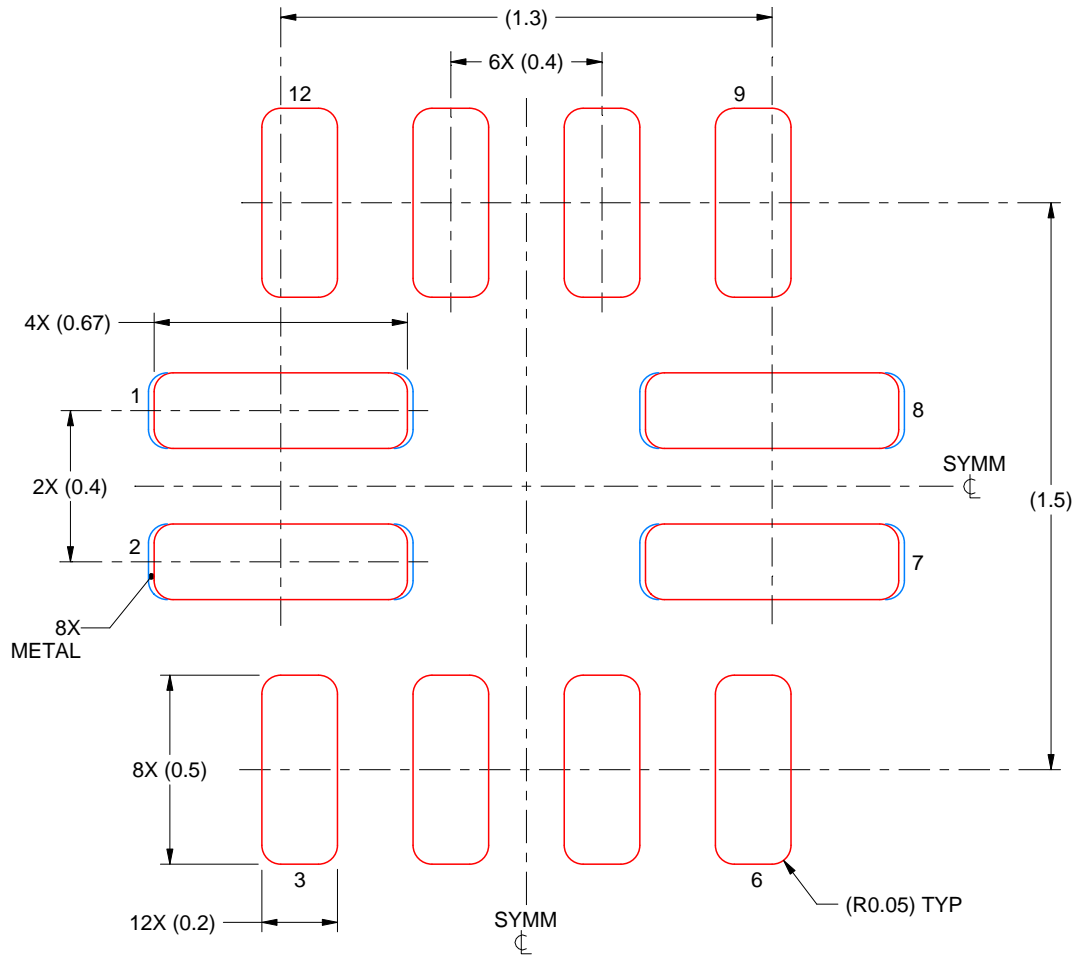
3. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).

# EXAMPLE STENCIL DESIGN

RWB0012A

X2QFN - 0.4 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



## SOLDER PASTE EXAMPLE BASED ON 0.1 mm THICK STENCIL

PADS 1,2,7 & 8  
96% PRINTED SOLDER COVERAGE BY AREA  
SCALE:50X

4221631/B 07/2017

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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